

4 3 2 1

PART NO. SEE TABLE 1

REVISIONS			
LTR	DESCRIPTION	Drawing	DATE
A	Initial Release for Manufacture	GARY	11/01/07
B	ADD PART NO.	GARY	12/24/08
C	修改圖面與實物相符	Three	11/17/09

CUSTOMER DRAWING

TABLE 1

020-01-00395	15 U" GOLD	PA9T BLACK	GP	WITH COVER
020-01-00396	15 U" GOLD	LCP BLACK	GP	WITH COVER
020-01-00325	15 U" GOLD	PA9T BLACK	GP	W/O COVER
020-01-00326	15 U" GOLD	LCP BLACK	GP	W/O COVER
PART NO.	PLATED	COLOR FOR THE PLASTIC	NOTE1	NOTE2

NOTE:

1.MATERIAL :
 HOUSING : High Temperature Thermoplastic ,
 UL94V-0, COLOR : BLACK
 TERMINAL(max): Copper Alloy,THICKNESS = 0.30 mm
 TERMINAL(min): Copper Alloy,THICKNESS = 0.25 mm
 FORKLOCK: Copper Alloy,THICKNESS = 0.30 mm

2.PLATING:
 CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE(SEE TABLE1)
 SOLDER TAIL:150u"MIN MISTY TIN 50u" MIN NICKEL UNDERPLATE
 GOLD SPECIFICATION:SEE TABLE

3.ELECTRONICAL SPECIFICATION:
 CURRENT RATING: 1.5 AMPERE PER CONTACT
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.
 INSULATION RESISTANCE: 1000 MEGOHMS MIN.
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC.
 OPERATING TEMPERATURE: -20°C~+85°C

RECOMMENDED PCB LAYOUT

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS .X ± 0.20 .XX ± 0.15 ANGLE: X ± 3'	APPROVALS		DATE	TITLE: ASSEMBLY OF SAS 29P VERTICAL DIP (2 ROWS)NONE POST 無凸點
	DRAWN	Three	11/17/09	
CHECKED				
APPROVALS				
SIZE mm	SCALE : 1 : 1	DRAWING NO. 000551	REV. C	
ID NO.	XXXXXXXXXX	SHEET 1 OF 1		

DESCRIPTION

NO

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